

# MBR30300CT / MBR30300FCT

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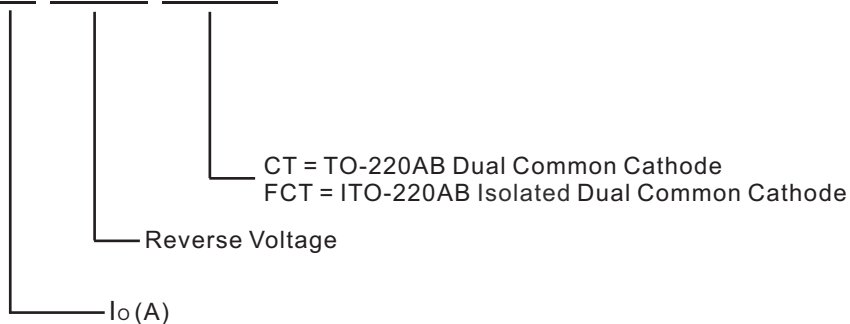
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## Part Nomenclature

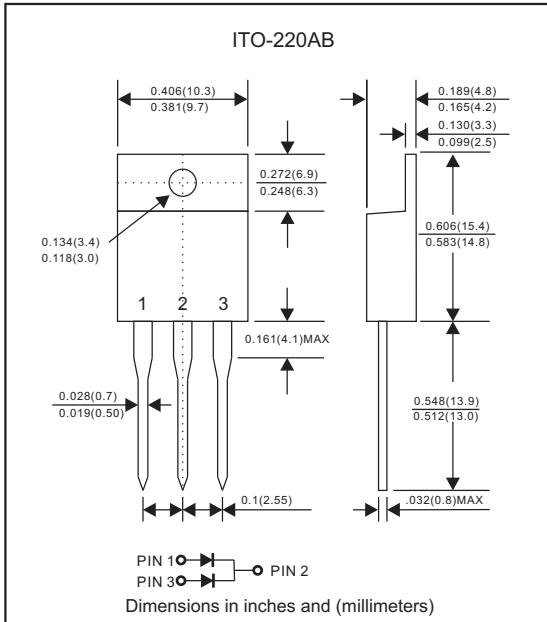
### MBR30 300 XXX



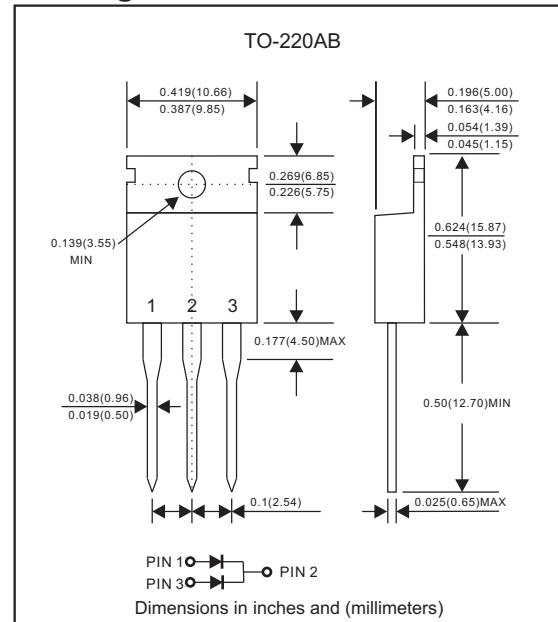
# MBR30300CT / MBR30300FCT

## 30A High Barrier Power Schottky Rectifiers - 300V

### Package outline



### Package outline



### Features

- 150°C operating junction temperature.
- Offer 15A half wave and 30A full wave rectification.
- Low power loss, high efficiency.
- High current capability
- High surge capability.
- Guardring for overvoltage protection.
- Low stored charge majority carrier conduction
- Lead-free parts meet RoHS requirements.
- Suffix "-H" indicates Halogen-free part, ex. MBR30300CT-H.

### Mechanical data

- Epoxy : UL94-V0 rated flame retardant
- Case : JEDEC ITO-220AB or TO-220AB molded plastic body over passivated chip
- Lead : Axial leads, solderable per MIL-STD-202, Method 208 guranteed
- Polarity: As marked
- Mounting Position : Any
- Weight : ITO-220AB Approximated 1.70 gram
- Weight : TO-220AB Approximated 2.10 gram

### Maximum ratings (AT $T_A=25^\circ\text{C}$ unless otherwise noted)

PARAMETER	Symbol	MBR30300CT	MBR30300FCT	Unit
Maximum repetitive peak reverse voltage	$V_{RRM}$	300		Volts
Maximum RMS voltage	$V_{RMS}$	210		Volts
Maximum DC blocking voltage	$V_{DC}$	300		Volts
Maximum average forward rectified current See Fig. 1	$I_O$	30		A
Peak forward surge current 8.3ms single half sine-wave	$I_{FSM}$	200		A
Operating junction temperature range	$T_J$	-65 to +150		°C
Storage temperature range	$T_{STG}$	-65 to +175		°C

### Electrical characteristics (AT $T_A=25^\circ\text{C}$ unless otherwise noted)

PARAMETER	Symbol	MBR30300CT	MBR30300FCT	Unit
Maximum forward voltage per leg at $I_F=15\text{A}$ $T_J=25^\circ\text{C}$	$V_F$	1.05		Volts
Typical forward voltage per leg at $I_F=30\text{A}$ $T_J=25^\circ\text{C}$		0.85		
		1.15		
		0.93		
Maximum reverse current at rated $V_{DC}$ per leg $T_J=25^\circ\text{C}$	$I_R$	0.005		mA
		10		

### Thermal characteristics

PARAMETER	Symbol	MBR30300CT	MBR30300FCT	Unit
Typical thermal resistance junction to case per leg	$R_{\theta JC}$	2.0	4.0	°C/W

## Rating and characteristic curves (MBR30300CT / MBR30300FCT)

Fig. 1 - Forward Current Derating Curve

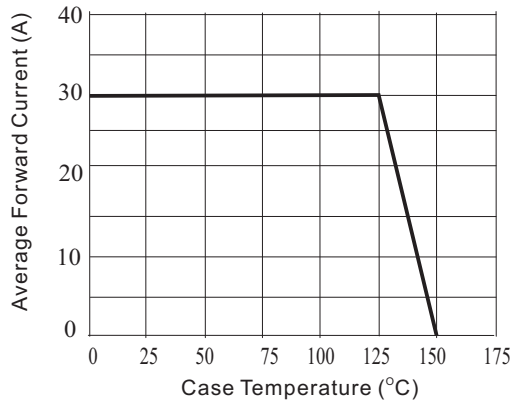


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

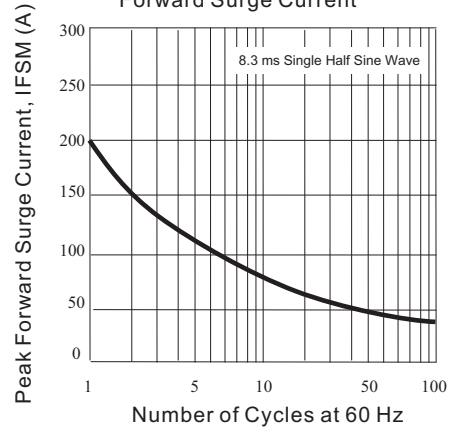


Fig. 3 - Typical Forward Characteristics

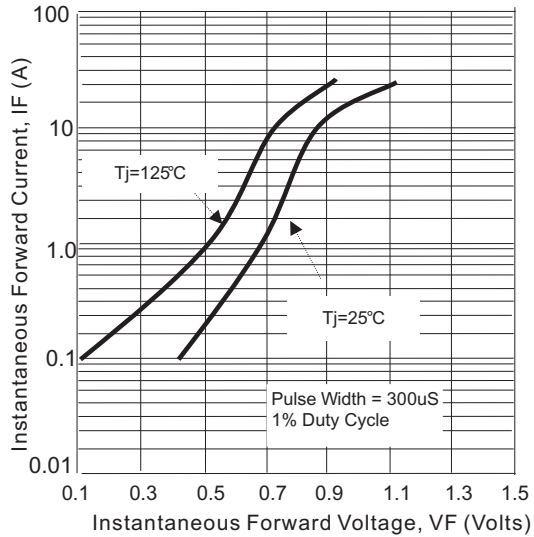
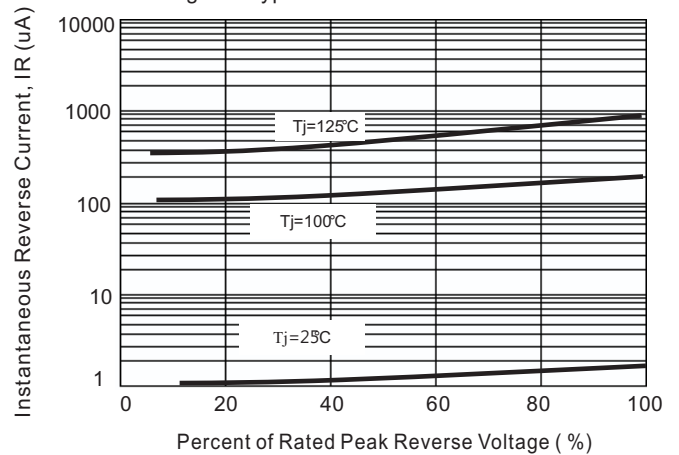


Fig. 4 - Typical Reverse Characteristics



# MBR30300CT / MBR30300FCT

## Pinning information

Pin	Simplified outline	Symbol
Pin1 anode Pin2 cathode Pin3 anode		

## Marking

Type number	Marking code
MBR30300CT	MBR30300CT
MBR30300FCT	MBR30300FCT

## Tube packing

PACKAGE	TUBE (pcs)	TUBE SIZE (m/m)	BOX (pcs)	INNER BOX (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
ITO-220AB	50	525*32*7.0	1,000	555*150*40	580*230*175	5,000	15.0

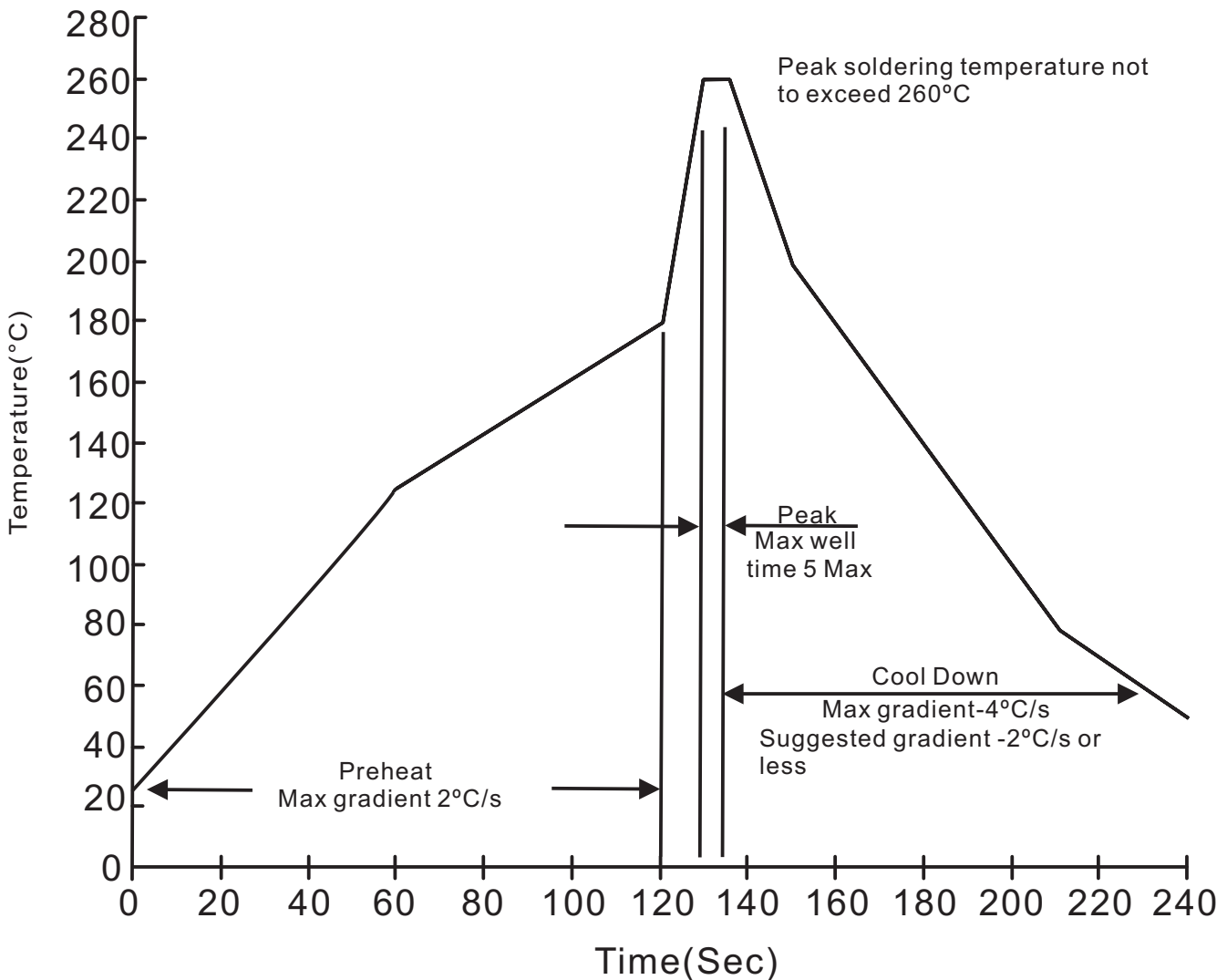
  

PACKAGE	TUBE (pcs)	TUBE SIZE (m/m)	BOX (pcs)	INNER BOX (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
TO-220AB	50	525*32*7.5	1,000	555*150*40	580*230*175	5,000	15.0

# MBR30300CT / MBR30300FCT

## Suggested thermal profiles for soldering processes

### 1. Lead free temperature profile wave-soldering



**MBR30300CT / MBR30300FCT****High reliability test capabilities**

Item Test	Conditions	Reference
1. Solder Resistance	at $260\pm 5^{\circ}\text{C}$ for $10\pm 2\text{sec}$ . immerse body into solder $1/16''\pm 1/32''$	MIL-STD-750D METHOD-2031
2. Solderability	at $245\pm 5^{\circ}\text{C}$ for 5 sec.	MIL-STD-202F METHOD-208
3. High Temperature Reverse Bias	$V_R=80\%$ rate at $T_J=150^{\circ}\text{C}$ for 168 hrs.	MIL-STD-750D METHOD-1038
4. Forward Operation Life	Rated average rectifier current at $T_A=25^{\circ}\text{C}$ for 500hrs.	MIL-STD-750D METHOD-1027
5. Intermittent Operation Life	$T_A = 25^{\circ}\text{C}$ , $I_F = I_o$ On state: power on for 5 min. off state: power off for 5 min. on and off for 500 cycles.	MIL-STD-750D METHOD-1036
6. Pressure Cooker	$15P_{SIG}$ at $T_A=121^{\circ}\text{C}$ for 4 hrs.	JESD22-A102
7. Temperature Cycling	$-55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ dwelled for 30 min. and transferred for 5min. total 10 cycles.	MIL-STD-750D METHOD-1051
8. Forward Surge	8.3ms single half sine-wave , one surge.	MIL-STD-750D METHOD-4066-2
9. Humidity	at $T_A=85^{\circ}\text{C}$ , RH=85% for 1000hrs.	MIL-STD-750D METHOD-1021
10. High Temperature Storage Life	at $175^{\circ}\text{C}$ for 1000 hrs.	MIL-STD-750D METHOD-1031